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FIRST NAMED INVENTOR APPLICATION NO. FILING DATE ATTORNEY DOCKET NO. CONFIRMATION NO. 09/770,864 01/26/2001 Douglas M. Albert IRVI.PAU.40 7129 7590 12/08/2003 EXAMINER Joseph C. Andras TRINH, MINH N Myers, Dawes & Andras ART UNIT PAPER NUMBER 19900 MacArthur Boulevard, Suite 1150 Irvine, CA 92612 3729

Please find below and/or attached an Office communication concerning this application or proceeding.

			/\s
Office Action Summary	Application No.	Applicant(s)	
	09/770,864	ALBERT ET AL.	
	Examiner	Art Unit	
	Minh Trinh	3729	
The MAILING DATE of this communication ap Period for Reply	pears on the cover sheet w	ith the correspondence address	
A SHORTENED STATUTORY PERIOD FOR REPL THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1. after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a replif NO period for reply is specified above, the maximum statutory period. - Failure to reply within the set or extended period for reply will, by statudent of the second patent term adjustment. See 37 CFR 1.704(b). Status	.136(a). In no event, however, may a oly within the statutory minimum of thin will apply and will expire SIX (6) MOI te, cause the application to become Al	reply be timely filed ty (30) days will be considered timely. ITHS from the mailing date of this communication. BANDONED (35 U.S.C. § 133).	
1) Responsive to communication(s) filed on RC	E filed on 9/22/2003.		
2a) ☐ This action is FINAL . 2b) ☑ This	s action is non-final.		
 Since this application is in condition for allows closed in accordance with the practice under 			
Disposition of Claims			
 4)	2 <u>-45</u> is/are withdrawn from e rejected.	consideration.	
Application Papers	or election requirement.	•	
9) The specification is objected to by the Examin	or		
10) The drawing(s) filed on is/are: a) ac		by the Examiner.	
Applicant may not request that any objection to the			
Replacement drawing sheet(s) including the correct	ction is required if the drawing	(s) is objected to. See 37 CFR 1.121(d).	
11)☐ The oath or declaration is objected to by the E	Examiner. Note the attache	d Office Action or form PTO-152.	
Priority under 35 U.S.C. §§ 119 and 120			
12) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of: 1. Certified copies of the priority document 2. Certified copies of the priority documents. Copies of the certified copies of the priority application from the International Bureats * See the attached detailed Office action for a list 13) Acknowledgment is made of a claim for domest since a specific reference was included in the first sentence of the priority documents. 3. Acknowledgment is made of a claim for domest since a specific reference was included in the first sentence of the foreign language priority. Acknowledgment is made of a claim for domest reference was included in the first sentence of the foreign language priority.	nts have been received. Its have been received in A ority documents have been au (PCT Rule 17.2(a)). It of the certified copies not tic priority under 35 U.S.C. Inst sentence of the specific rovisional application has be	application No received in this National Stage received. § 119(e) (to a provisional application ation or in an Application Data Shee een received. §§ 120 and/or 121 since a specific	
Attachment(s)	_		
I) ☑ Notice of References Cited (PTO-892) ☑ Notice of Draftsperson's Patent Drawing Review (PTO-948) ☑ Information Disclosure Statement(s) (PTO-1449) Paper No(s)	5) Notice of	Summary (PTO-413) Paper No(s) nformal Patent Application (PTO-152)	

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DETAILED ACTION

Continued Prosecution Application

- 1. Receipt is acknowledged of the "conditional" request for RCE application is acceptable and a RCE has been established. An action on the CPA follows.
- 2. The text of those sections of Title 35, U.S. Code not included in this action can be found in a prior Office action.
- 3. Claims 1-3, 6, 11 and 46-47 are rejected under 35 U.S.C. 103(a) as being unpatentable over Carson et al (US 5,701,233) in view of Dlugokecki (US 5,700,697).

Carson et al disclose the method for making stackable microcircuit device comprising steps of providing a plastic encapsulated microcircuit (PEM, or module, 10, 12, 14, col. 8, lines 46-48) that includes a microcircuit having an active surface containing IC and bonding pad 52 or 54 (see Figs. 4-5, and the discussion at col. 9, lines 57-59). Carson et al, however is silently disclosed the encapsulant is being contacted the microcircuit 52 and the modifying the encapsulating to expose a conductive member as so to connecting the PEM to the IC circuit I/O bonding pad. Dlugokecki teaches the step of removing the encapsulant (see Fig. 7, col. 10, lines 58-63) to produce the modified PEM having a modified surface on which the modified surface is exposed a conductive member (see col. 2, lines 31-51). Therefore, it would have been obvious to one ordinary skill in the art at the time the invention was made to employ the Dlugokecki's teaching of removing the encapsulant material to expose a

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conductive member of the PEM onto the method invention of Carson et al in order to expose part of the conductive member for various known benefits such as reconstructing and/or integrating a number of IC circuits to form a tacking electronic circuit assembly.

As applied to claim 2, noting figures 4 and 6 of Dlugokecki depicts the forming leads 65 on the modified PEM to an edge of the modified PEM.

As applied to claim 3, regarding the microcircuit is a pre-tested circuit. It would have been an obvious matter of design choice to choose any desired type of circuitry since applicant has not disclosed that the microcircuit is a pre-tested microcircuit is a critical feature of the invention and it appears that the invention would perform equally well with the circuit module circuitry as taught by each of the applied prior art references.

As applied to claim 6, noting the Dlugokecki reference discloses the concept of covering the lead by applying insulation layer (see abstract lines 10-13).

As applied to claim 11, each of the applied prior art references disclose the limitation of claim 11 a conductive member (solder) for connecting wire bond.

Limitations of claims 46-47 are met by as discussed above (note each of the prior art references discloses the body or substrate is plastic).

4. Claims 5, 12 and 20-21 are rejected under 35 U.S.C. 103(a) as being unpatentable over Carson et al in view of Dlugokecki and further in view of Young et al (US 6,429,028).

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As applied to claim 5, Carson et al or Dlugokecki as modified and relied upon above do not teach the step of thinning a backside of the modified PEM and the conductive member is a gold ball. Young et al teach the thinning a backside of thickness of the PEM (col. 9, lines 32-34); and the conductive member is a gold ball as recited in claims 12, 20 and 21 (see col. 7, lines 59-60). Therefore, it would have been obvious to one ordinary skill in the art, at the time of the invention to employ the Young's teaching as described above onto the modified method invention of Carson et al or Dlugokecki in order to obtain a desired interconnecting structure with the exact size and material associated requirement therefrom.

Limitations of claims 12, 20 and 21 (refer to the above discussion). Moreover, it would have been an obvious matter of design choice to choose any desired conductive member, since applicant has not disclosed that the material is gold ball as recited in claims 12, 20 and 21 would solve any stated problem or is for any particular purpose and it appears that the invention would perform equally well with the teaching of the applied prior art (i.e., solder wire bond pads).

Response to Arguments

5. Applicant's arguments with respect to claims 1-3, 5-6,11-12 and 46-47 have been considered but are most in view of the new ground(s) of rejection.

Prior Art References

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6. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure. Prior art references are cited for their teaching of method of

stacking PEM devices.

Conclusion

7. Any inquiry concerning this communication or earlier communications from the

examiner should be directed to Minh Trinh whose telephone number is (703) 305-2887.

The examiner can normally be reached on Monday -Thursday 8:00 am to 4:30 pm.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's

supervisor, Peter Vo can be reached on (703) 308-1789. The fax phone numbers for the

organization where this application or proceeding is assigned are (703) 305-7307 for

regular communications and (703) 305-3579 for After Final communications.

Any inquiry of a general nature or relating to the status of this application or

proceeding should be directed to the receptionist whose telephone number is (703) 308-

1148.

Examiner Group 3729

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December 1, 2003